

# **High Efficient Surface Mount Rectifiers**

#### **FEATURES**

- Glass passivated junction chip
- Ideal for automated placement
- Low profile package
- Low power loss, high efficiency
- Fast switching for high efficiency
- Moisture sensitivity level: level 1, per J-STD-020
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21 definition







### MECHANICAL DATA

Case: Sub SMA Sub SMA

Molding compound, UL flammability classification rating 94V-0

Base P/N with suffix "G" on packing code - green compound (halogen-free)

Base P/N with prefix "H" on packing code - AEC-Q101 qualified **Terminal:** Matte tin plated leads, solderable per JESD22-B102

Meet JESD 201 class 1A whisker test

with prefix "H" on packing code meet JESD 201 class 2 whisker test

**Polarity:** Indicated by cathode band **Weight:** 0.019 g (approximately)

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS (T <sub>A</sub> =25℃ unless otherwise noted)										
DADAMETED	CVAADOL	HS	HS	HS	HS	HS	HS	HS	HS	LINIT
PARAMETER	SYMBOL	1AL	1BL	1DL	1FL	1GL	1JL	1KL	1ML	UNIT
Marking code		HAL	HBL	HDL	HFL	HGL	HJL	HKL	HML	
Maximum repetitive peak reverse voltage	$V_{RRM}$	50	100	200	300	400	600	800	1000	V
Maximum RMS voltage	$V_{RMS}$	35	70	140	210	280	420	560	700	V
Maximum DC blocking voltage	$V_{DC}$	50	100	200	300	400	600	800	1000	V
Maximum average forward rectified current	I <sub>F(AV)</sub>	1			Α					
Peak forward surge current, 8.3 ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	30			Α					
Maximum instantaneous forward voltage (Note 1) @ 1 A	V <sub>F</sub>	0.95 1.3 1.7			1.7		V			
Maximum reverse current @ rated VR T <sub>J</sub> =25 ℃ T <sub>J</sub> =125 ℃	I <sub>R</sub>	5 150		μA						
Typical junction capacitance (Note 2)	Cj	20 15			pF					
Maximum reverse recovery time (Note 3)	Trr	50 75			ns					
Typical thermal resistance	$R_{\theta jA}$	100			°C/W					
Operating junction temperature range	TJ	- 55 to +150			оС					
Storage temperature range	T <sub>STG</sub>	- 55 to +150			οС					

Note 1: Pulse test with PW=300µs, 1% duty cycle

Note 2: Measured at 1 MHz and Applied VR=4.0 Volts.

Note 3: Reverse Recovery Test Conditions:  $I_F$ =0.5A,  $I_R$ =1.0A,  $I_{RR}$ =0.25A





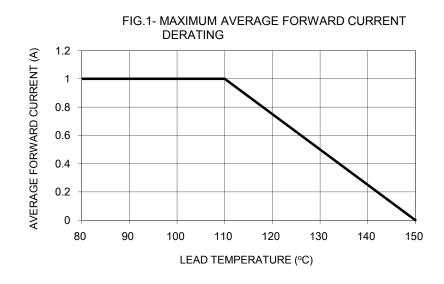
ORDERING	ORDERING INFORMATION					
PART NO.	AEC-Q101	PACKING CODE	GREEN COMPOUND	PACKAGE	PACKING	
	QUALIFIED		CODE			
	RU		Sub SMA	1,800 / 7" Plastic reel (8mm tape)		
		RV		Sub SMA	3,000 / 7" Plastic reel (8mm tape)	
		RT		Sub SMA	7,500 / 13" Paper reel (8mm tape)	
		MT		Sub SMA	7,500 / 13" Plastic reel (8mm tape)	
		RQ		Sub SMA	10,000 / 13" Paper reel (8mm tape)	
HS1xL Prefix "H"	MQ	Suffix "G"	Sub SMA	10,000 / 13" Plastic reel (8mm tape)		
(Note 1)	(Note 1)	R3	Suinx G	Sub SMA	1,800 / 7" Plastic reel (12mm tape)	
		RF		Sub SMA	3,000 / 7" Plastic reel (12mm tape)	
		R2		Sub SMA	7,500 / 13" Paper reel (12mm tape)	
		M2		Sub SMA	7,500 / 13" Plastic reel (12mm tape)	
		RH		Sub SMA	10,000 / 13" Paper reel (12mm tape)	
		MH	]	Sub SMA	10,000 / 13" Plastic reel (12mm tape)	

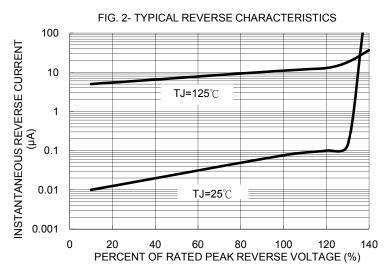
Note 1: "x" defines voltage from 50V (HS1AL) to 1000V (HS1ML)

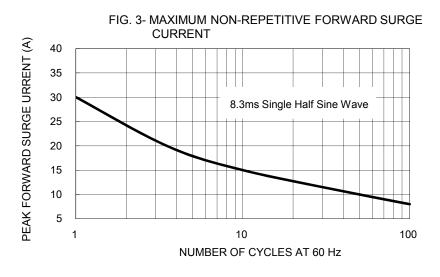
EXAMPLE						
PREFERRED P/N	PART NO.	AEC-Q101	PACKING CODE	PACKING CODE GREEN COMPOUND		
		QUALIFIED		CODE		
HS1JL RU	HS1JL		RU			
HS1JL RUG	HS1JL		RU	G	Green compound	
HS1JLHRU	HS1JL	Н	RU		AEC-Q101 qualified	

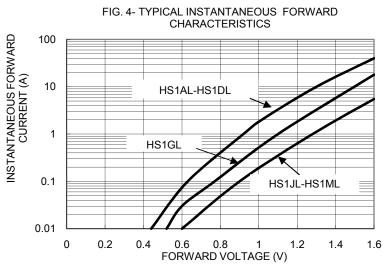
### RATINGS AND CHARACTERISTICS CURVES

(TA=25°C unless otherwise noted)

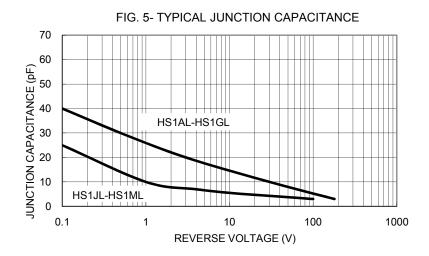




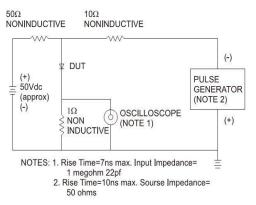


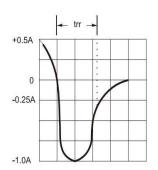




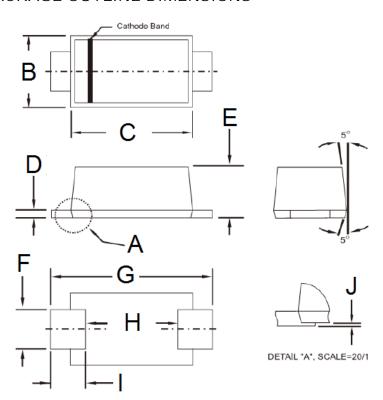


### FIG.6- REVERSE RECOVERY TIME CHARACTERISTIC AND TEST CIRCUIT DIAGRAM



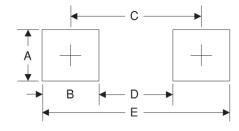


### PACKAGE OUTLINE DIMENSIONS



DIM.	Unit	(mm)	Unit (inch)			
DIIVI.	Min	Max	Min	Max		
В	1.70	1.90	0.067	0.075		
С	2.70	2.90	0.106	0.114		
D	0.16	0.30	0.006	0.012		
E	1.23	1.43	0.048	0.056		
F	0.80	1.20	0.031	0.047		
G	3.40	3.80	0.134	0.150		
Н	2.45	2.60	0.096	0.102		
I	0.35	0.85	0.014	0.033		
J	0.00	0.10	0.000	0.004		

## SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
Α	1.4	0.055
В	1.2	0.047
С	3.1	0.122
D	1.9	0.075
E	4.3	0.169

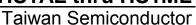
### MARKING DIAGRAM



P/N = Marking Code G = Green Compound

YW = Date Code

F = Factory Code





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HS1AL R2G HS1AL R3G HS1AL RQG HS1DL R2G HS1DL R3G HS1DL RQG HS1FL R2G HS1FL R3G HS1FL R3G HS1FL RQG HS1GL R2G HS1GL R3G HS1GL RQG HS1JL R2G HS1JL R3G HS1JL RQG HS1KL R2G HS1KL R3G HS1KL RQG HS1ML R2G HS1ML R3G HS1ML RQG HS1DLHR3G HS1JLHR2 HS1JLHRQG HS1BLHR3G HS1FLHR2G HS1ALHRQ HS1MLHR3G HS1MLHR3 HS1FLHRQ HS1KLHR3G HS1FLHR3 HS1DLHRQG HS1FLHR3G HS1GLHR3 HS1ALHR3G HS1DLHR3 HS1KLHRQG HS1FLHR2 HS1ALHR2G HS1GLHRQ HS1KLHR3 HS1GLHRQG HS1JLHR3G HS1JLHRQG HS1KLHR3 HS1GLHRQG HS1JLHR3G HS1JLHRQG HS1KLHR2G HS1GLHRQG HS1KLHR2G HS1ALHR2G HS1MLHRQG HS1KLHR2 HS1ALHRQG HS1MLHRQG HS1KLHRQG HS1MLHRQG HS1MLHQG HS1MLHQG HS1MLHQG HS1MLHQG HS1MLHQG HS1MLHQG HS1M